



(1.27 mm) .050"

IICRO BOARD STACKER

SPECIFICATIONS

For complete specifications see www.samtec.com?DWM or www.samtec.com?HDWM

Insulator Material:

Terminal Material: Phosphor Bronze

Phosphor Biorize
Plating:
Au or Sn over
50 µ" (1.27 µm) Ni
Operating Temp Range:
-55 °C to +105 °C with Tin
-55 °C to +125 °C with Gold

RoHS Compliant:

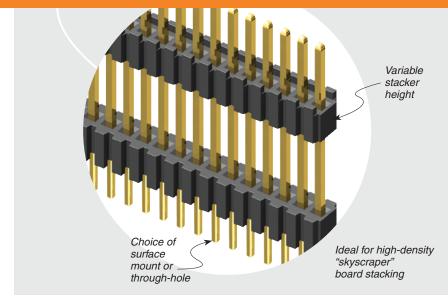
PROCESSING

Lead-Free Solderable:

Yes SMT Lead Coplanarity: (0.15 mm) .006" max* (.004" stencil solution may be available; contact IPG@samtec.com)

Mates with:

SMS, SLM, RSM



ROW

OPTION

-S

= Single

Row

STACKER

HEIGHT

-"XXX"

= Stacker

Height

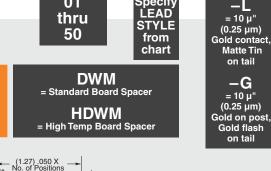
Example:

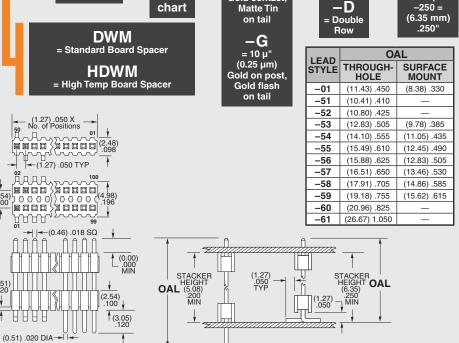
RECOGNITIONS

For complete scope of recognitions see www.samtec.com/quality



TYPE NO. PINS **LEAD STRIP PER ROW** STYLE Specify LEAD 01 thru **STYLE** 50 from chart **DWM** = Standard Board Spacer HDWM





PLATING

OPTION

OTHER OPTION

"XXX"

= Polarized Position (Specify position of omitted pin)

-SM

= Surface Mount (Requires HDWM. 02 thru 40 positions only.)

-A

= Alignment Pin (Requires HDWM. 6 positions min -D only.)
Metal or plastic at
Samtec discretion (N/A with -LC)

– LC

= Locking Clip (Requires HDWM. (5 positions min. -D only) (N/A with -A) (Mànual placement required)

– P = Pick & Place Pad (Requires HDWM)

Notes:

For added mechanical stability, Samtec recommends mechanical board spacers be used in applications with gold or selective gold plated connectors. Contact ipg@samtec.com for more information.

ALSO AVAILABLE

(MOQ Required)

Other platings

This Series is non-standard, non-returnable.

Due to technical progress, all designs, specifications and components are subject to change without notice